


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	AMS/20/12447	
1.3 Title of PCI	FE alignment (asic with PIX) for dual source preparation for LPS22HHTR, LPS22HHQTR,LPS22CHTR.	
1.4 Product Category	See Products List	
1.5 Issue date	2020-11-16	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	NEMETH KRISZTINA
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Andrea Mario ONETTI
2.1.2 Marketing Manager	Simone FERRI
2.1.3 Quality Manager	Michele CALDERONI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Wafer Fab (Process)	Passivation : change in nature (material composition, doping type and level) or final thickness.	ST France

4. Description of change

	Old	New
4.1 Description	Without PIX	with PIX
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	2nd BE plant requests pix implementation
5.2 Customer Benefit	CAPACITY INCREASE

6. Marking of parts / traceability of change

6.1 Description	By code
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7. Timing / schedule

7.1 Date of qualification results	2021-01-04
7.2 Intended start of delivery	2021-01-11
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

12447 Public product.pdf

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	LPS22HHTR	

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Public Products List

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PCI Title : FE alignment (asic with PIX) for dual source preparation for LPS22HHTR, LPS22HHQTR,LPS22CHTR.

PCI Reference : AMS/20/12447

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

LPS22CHTR	LPS22HHTR	
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